

Product specifications contained herein may be changed without prior notice. It is therefore advisable to contact Purdy Electronics before proceeding with the design of equipment incorporating this product.

## AND4RA

# **GaAlAs Ultra Bright Red Light Emission Surface Mount Package**

#### **Features**

- Small package size
- 2.0 (l) x 1.25 (w) x 1.1 (h) size
- · Suitable for DIP and REFLOW soldering
- Recommended Forward Current: 10 mA
- RoHS Compliant

#### Maximum Ratings ( $T_a = 25$ °C)

Characteristics	Symbol	Rating	Unit
Forward Current	I <sub>F</sub>	40	mA
Reverse Voltage	V <sub>R</sub>	5	V
Power Dissipation	P <sub>D</sub>	110	mW
Operating Temperature Range	T <sub>Opr</sub>	-40 to 85	°C
Storage Temperature Range	T <sub>Sig</sub>	-40 to 90	°C

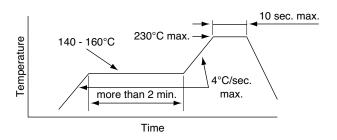
### Electro-Optical Characteristics ( $T_a = 25$ °C)

Characteristics	Symbol	Test Condition	Minimum	Typical	Maximum	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> = 20 mA	_	1.7	2.4	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> = 5 V	-	-	10	μΑ
Luminous Intensity	I <sub>V</sub>	I <sub>F</sub> = 20 mA	20	40	-	mcd
Peak Emission Wavelength	l <sub>P</sub>	I <sub>F</sub> = 20 mA	_	660	-	nm
Spectral Line Half Width	Δλ	I <sub>F</sub> = 20 mA	_	20	_	nm
Dominant Wavelength	λd	I <sub>F</sub> = 20 mA	_	643	-	nm
Full Viewing Angle	θ	I <sub>V</sub> = 1/2 Peak	_	140	_	degree

#### Precaution

Please be careful of the following:

- 1. Manual soldering: maximum temperature of iron tip: 260°C max. Soldering time: within 5 sec. per solder-land
  - Soldering portion of lead: up to 1.6 mm from the body of the device
- 2. Reflow solder: recommended condition is as follows:



The following soldering patterns are recommended for reflow soldering

